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LIST OF PATENTS AND
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APPLICANT: AMMAR

GROUP:

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIALS		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING IF APPROPRIATE
<i>[Signature]</i>	AA	5,423,080	06/06/95	Perret et al.	455	90	
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION Yes -- No
	AL						

OTHER ART

(Including Author, Title, Date, Pertinent Pages, etc.)

<i>[Signature]</i>	AM		Prabhu et al., "Co-Fired Ceramic on Metal Multichip Modules For Advanced Military Packaging," Aerospace and Electronics Conference, Proceedings of the IEEE, May 24, 1993, pp. 217-222.
<i>[Signature]</i>	AN		Jayaraj et al., "RF Characterization of a Low Cost Multichip Packaging Technology For Monolithic Microwave and Millimeter Wave Integrated Circuits," 1995 URSI International Symposium on San Francisco, IEEE, October 25, 1995, pp. 443-446.
<i>[Signature]</i>	AO		Gutierrez et al., "A Thick Film Package for Microwave ICs," Proceedings of the Electronic Components and Technology Conference, IEEE, May 18, 1992, pp. 151-156.
	AP		

EXAMINER:

J. MONDT *[Signature]*

DATE CONSIDERED:

10/19/02

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; * Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



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